


APPLICATION DATA SHEET

Electronic Version v14

Stylesheet Version v14.0

Title of Invention	[METHOD OF FABRICATING A SOLDER MASK AND STRUCTURE OF A SUBSTRATE]		
Application Type : regular, utility Attorney Docket Number : 9246-US-PA			
Correspondence address: Customer Number: 31561			
			
Priority Data: Doc.No: 91118368; Country -TW ; Date: 2003-08-15 us-priority-claimed			
Inventors Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: TW Name prefix: Mr. Given Name: Yi-Chuan Family Name: Ding Residence: City of Residence: Kaohsiung Country of Residence: TW Address-1 of Mailing Address: No. 2, Wen-Chiang Rd., Address-2 of Mailing Address: City of Mailing Address: Kaohsiung State of Mailing Address: Postal Code of Mailing Address: Country of Mailing Address: TW Phone: Fax: E-mail: <u>Inventor 2:</u> Applicant Authority Type: Inventor			

Citizenship: TW
Name prefix: Mr.
Given Name: Yung-I
Family Name: Yeh
Residence:
City of Residence: Kaohsiung
Country of Residence: TW
Address-1 of Mailing Address: No. 26-1, Lane 860, Hou-Chang Rd.,
Address-2 of Mailing Address:
City of Mailing Address: Kaohsiung
State of Mailing Address:
Postal Code of Mailing Address:
Country of Mailing Address: TW
Phone:
Fax:
E-mail:

Attorney Information:

practitioner(s) at Customer Number:

31561



as our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.